506705627 06/09/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6752446

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HYEJUNG JUNG	08/09/2019
ALEXANDER JOHANN MARIA GOLITSCHEK EDLER VON ELBWART	08/07/2019
VIJAY NANGIA	08/08/2019
PRATEEK BASU MALLICK	08/07/2019
JOACHIM LOEHR	08/07/2019
RAVI KUCHIBHOTLA	08/18/2019
ROBERT T. LOVE	08/08/2019

RECEIVING PARTY DATA

Name:	LENOVO (SINGAPORE) PTE. LTD.
Street Address:	151 LORONG CHUAN
Internal Address:	# 02-01
City:	NEW TECH PARK
State/Country:	SINGAPORE
Postal Code:	556741

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17206014

CORRESPONDENCE DATA

(801)531-1929 Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 8019944646 Email: docket@kba.law

Correspondent Name: KUNZLER BEAN AND ADAMSON Address Line 1: 50 W BROADWAY, SUITE 1000 Address Line 4: SALT LAKE CITY, UTAH 84101

ATTORNEY DOCKET NUMBER:	SMM920180076-US-CNT
NAME OF SUBMITTER:	SARA MATLOCK
SIGNATURE:	/Sara Matlock/

PATENT REEL: 056484 FRAME: 0345

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DATE SIGNED:	06/09/2021	
Total Attachments: 8		
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PATENT REEL: 056484 FRAME: 0346

DOCKET NUMBER: SMM920180076-US-NP

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, Hyejung Jung, Northbrook, Illinois; Alexander Johann Maria Golitschek Edler von Elbwart, Darmstadt, Germany; Vijay Nangia, Woodridge, Illinois; Prateek Basu Mallick, Dreieich, Germany; Joachim Loehr, Wiesbaden, Germany; Ravi Kuchibhotla, Clarendon Hills, Illinois; and Robert T. Love, Barrington, Illinois; have sold, assigned and transferred, and do hereby sell, assign and transfer, unto Lenovo (Singapore) Pte. Ltd., a corporation of Singapore, having a place of business at 151, Lorong Chuan #02-01, New Tech Park, Singapore 556741, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions entitled "IDENTIFYING SYNCHRONIZATION SIGNAL/PHYSICAL BROADCAST CHANNEL BLOCK OCCASIONS" as described, illustrated in SMM920180076-US-NP and as described, illustrated and claimed in the following applications:

U.S. Application filed herein and entitled: "IDENTIFYING SYNCHRONIZATION SIGNAL/PHYSICAL BROADCAST CHANNEL BLOCK OCCASIONS"

U.S. Application No. 62/717,733, filed on August 10, 2018 entitled "APPARATUSES, METHODS, AND SYSTEMS FOR ACCESSING A NETWORK IN AN UNLICENSED SPECTRUM"

I hereby also sell, assign and transfer unto Assignee, the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and I further authorize Assignee to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby also sell, assign and transfer unto Assignee, the entire right, title and interest in and to other applications for Letters Patent on the inventions referenced in this Assignment and Agreement, and all rights, title and interest in and to all applications for Letters Patent in respect of the invention filed under any and all international conventions and treaties together with the entire right, title and interest in and to Letters Patent which may be issued upon the application(s) or any application(s) otherwise claiming priority

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(1) Legal Name of Inventor: Hyejung Jung

thereto, and upon any divisions, extensions, continuations, reissues and/or reexaminations of such application(s).

I further authorize Assignee to apply for Letters Patent directly in its own name where applicable, and to claim priority of the filing date of the application for Letters Patent filed under the laws of the applicable country and under the provisions of any and all international conventions and treaties.

I hereby authorize Assignee to request the Commissioner of Patents of the United States of America to issue any Letters Patents upon the aforesaid application, divisions, extensions, continuations, reissues or re-examinations, to Assignee, for the sole use and benefit of Assignee, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize Assignee to request the equivalent authorities in foreign countries to issue the patents of their respective countries to Assignee.

I agree that, when requested, I will, without charge to Assignee, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing, maintaining and enforcing patents for the inventions in any and all countries and for vesting title thereto in Assignee.

I covenant with Assignee that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

	Signature:	_Date:	Aug. 9, 2019
(2)	Legal Name of Inventor: Alexander Johann Maria Golitschek E	dler von E	llbwart
ì	Signature:	Date:	
(3)	Legal Name of Inventor: Vijay Nangia		
Š	Signature:	Date:	

thereto, and upon any divisions, extensions, continuations, reissues and/or reexaminations of such application(s).

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(1)	Legal Name of Inventor: Hyejung Jung	
	Signature:	Date:
(2)	Legal Name of Inventor: Alexander Johann Maria Golitschek	Edler von Elbwart
	Signature: KW SM Sh SMA	Date: 7 Ay 2019
(3)	Legal Name of Inventor: Vijay Nangia	
	Signature:	Date:

Page 2 of 3

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I covenant with Assignee that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

(1)	Legal Name of Inventor: Hyejung Jung	
	Signature:	Date:
(2)	Legal Name of Inventor: Alexander Johann Maria Golitschek E	dler von Elbwart
	Signature:	Date:
(3)	Legal Name of Inventor: Vijay Nangia	
	Signature: May Warpin	Date: <u>August 8, 2019</u>

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(4)	Legal Name of Inventor: Prateek Basu Mallick	
	Signature: Signature:	Date: Aug 07, 2019
(5)	Legal Name of Inventor: Joachim Loehr	
	Signature:	Date:
(6)	Legal Name of Inventor: Ravi Kuchibhotla	
	Signature:	Date:
(7)	Legal Name of Inventor: Robert T. Love	
	Signature:	Date:

Page 3 of 3

(4) Legal Name of Inventor: Prateek Basu Mallick	
Signature:	Date:
(5) Legal Name of Inventor: Joachim Loehr	
Signature: 20	Date: <u>Aug</u> 7 ^{±16} , 2015
(6) Legal Name of Inventor: Ravi Kuchibhotla	
Signature:	Date:
(7) Legal Name of Inventor: Robert T. Love	
Signatura	Date

(4) Legal Name of Inventor: Prateek Basu Mallick	
Signature:	Date:
(5) Legal Name of Inventor: Joachim Loehr	
Signature:	Date:
(6) Legal Name of Inventor: Ravi Kuchibhotla	
Signature:	Date:August 18 2019
(7) Legal Name of Inventor: Robert T. Love	
Signature:	Data

(4)	Legal Name of Inventor: Prateek Basu Mallick		
	Signature:	_Date:	
(5)	Legal Name of Inventor: Joachim Loehr		
	Signature:	Date:_	
(6)	Legal Name of Inventor: Ravi Kuchibhotla		
	Signature:	Date:_	
(7)	Legal Name of Inventor: Robert T. Love		
	Signature: OV	Date:	8/8/2019